

# 2.5V Drive Pch+SBD MOSFET

# **ES6U42**

#### Structure

Silicon P-channel MOSFET / Schottky barrier diode

#### Features

- 1) Pch MOSFET and schottky barrier diode are put in WEMT6 package.
- 2) High-speed switching, Low On-resistance.
- 3) Low voltage drive (2.5V drive).
- 4) Built-in Low VF schottky barrier diode.

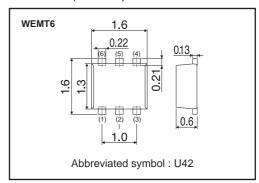
# Applications

Switching

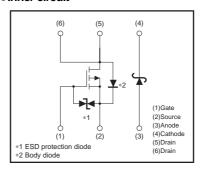
# Package specifications

	Package	Taping
Type	Code	T2R
	Basic ordering unit (pieces)	8000
ES6U42		0

# ● Dimensions (Unit: mm)



# •Inner circuit



# ● Absolute maximum ratings (Ta=25°C)

<MOSFET>

Parameter		Symbol	Limits	Unit
Drain-source voltage		VDSS	-20	V
Gate-source voltage		Vgss	±12	V
Drain current	Continuous	ID	±1.0	Α
Drain current	Pulsed	I <sub>DP</sub> *1	±4.0	Α
Source current	Continuous	Is	-0.4	Α
(Body diode)	Pulsed	I <sub>SP</sub> *1	-4.0	Α
Channel temperature		Tch	150	°C
Power dissipation		P <sub>D</sub> *2	0.7	W / ELEMENT

<sup>\*1</sup> Pw≤10µs, Duty cycle≤1% \*2 Mounted on a ceramic board

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Parameter	Symbol	Limits	Unit	
Repetitive peak reverse voltage	V <sub>RM</sub>	25	V	
Reverse voltage	VR	20	V	
Forward current	IF	0.5	A	
Forward current surge peak	I <sub>FSM</sub> *1	2.0	Α	
Junction temperature	Tj	150	°C	
Power dissipation	Pp *2	0.5	W / ELEMENT	

### <MOSFET and Di>

Parameter	Symbol	Limits	Unit	
Power dissipation	P <sub>D</sub> *	0.8	W / TOTAL	
Range of storage temperature	Tstg	-55 to +150	°C	

<sup>\*</sup> Mounted on a ceramic board

<sup>\*1 60</sup>Hz • 1 cycle \*2 Mounted on a ceramic board

# ●Electrical characteristics (Ta=25°C)

<MOSFET>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	_	_	±10	μА	Vgs= ±12V, Vps=0V
Drain-source breakdown voltage	V(BR) DSS	-20	-	_	V	I <sub>D</sub> = -1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	IDSS	-	-	-1	μΑ	V <sub>DS</sub> = -20V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	-0.7	_	-2.0	V	V <sub>DS</sub> = -10V, I <sub>D</sub> = -1mA
Static drain-source on-state		_	280	390	mΩ	I <sub>D</sub> = -1A, V <sub>G</sub> S= -4.5V
resistance	R <sub>DS</sub> (on)*	_	310	430	mΩ	I <sub>D</sub> = -1A, V <sub>G</sub> S= -4V
		-	570	800	mΩ	I <sub>D</sub> = -0.5A, V <sub>G</sub> S= -2.5V
Forward transfer admittance	Y <sub>fs</sub> *	0.7	-	_	S	V <sub>DS</sub> = -10V, I <sub>D</sub> = -0.5A
Input capacitance	Ciss	_	150	_	pF	V <sub>DS</sub> = -10V
Output capacitance	Coss	_	20	_	pF	V <sub>GS</sub> = 0V
Reverse transfer capacitance	Crss	_	20	_	pF	f= 1MHz
Turn-on delay time	t <sub>d (on)</sub> *	_	9	_	ns	V <sub>DD</sub> ≒ –15V
Rise time	tr *	_	8	_	ns	Vgs= -4.5V
Turn-off delay time	t <sub>d (off)</sub> *	-	25	_	ns	lb= −0.5A RL≒30Ω
Fall time	t <sub>f</sub> *	_	10	_	ns	R <sub>G</sub> = 10Ω
Total gate charge	Qg *	_	2.1	-	nC	V <sub>DD</sub> ≒-15V, V <sub>GS</sub> =-4.5V
Gate-source charge	Q <sub>gs</sub> *	_	0.5	_	nC	I <sub>D</sub> =−1A, R <sub>L</sub> ≒15Ω
Gate-drain charge	Q <sub>gd</sub> *	_	0.5	_	nC	R <sub>G</sub> = 10Ω

<sup>\*</sup>Pulsed

# <Body diode characteristics (Source-drain)>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp *	_	_	-1.2	V	I <sub>S</sub> = -1.0A, V <sub>G</sub> S=0V

<sup>\*</sup>Pulsed

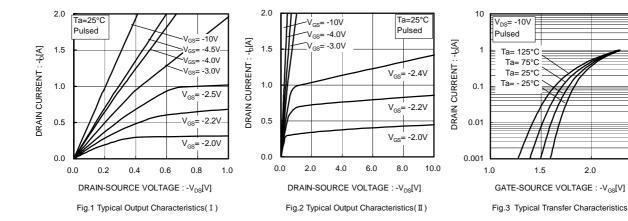
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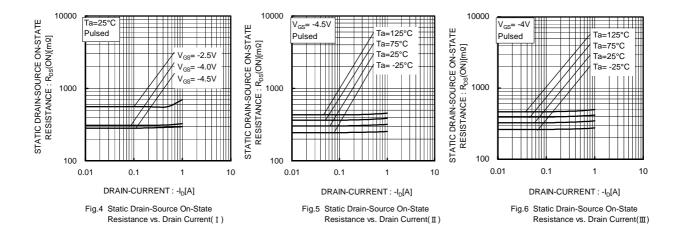
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	VF	_	_	0.36	V	I <sub>F</sub> = 0.1A
		_	_	0.52	V	IF= 0.5A
Reverse current	IR	_	_	100	μΑ	V <sub>R</sub> = 20V

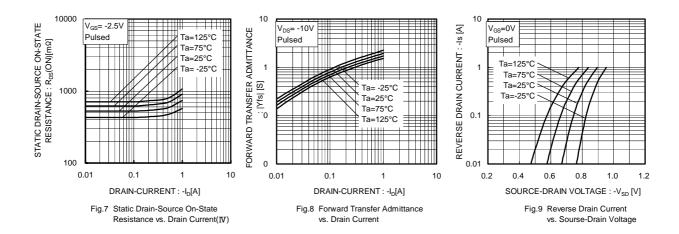
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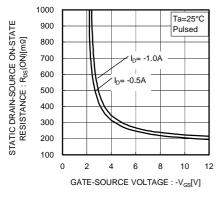
#### Electrical characteristics curves

#### <MOSFET>









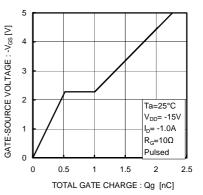


Fig.10 Static Drain-Source On-State Resistance vs. Gate Source Voltage

Fig.11 Switching Characteristics

Fig.12 Dynamic Input Characteristics

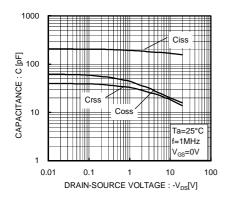


Fig.13 Typical Capacitance vs. Drain-Source Voltage

# <Di>

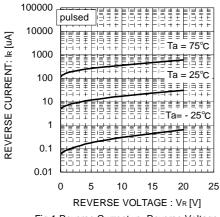
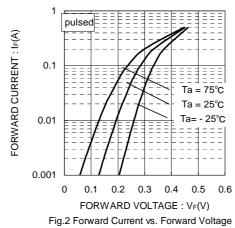


Fig.1 Reverse Current vs. Reverse Voltage



0

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#### ●Measurement circuit

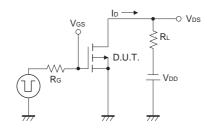


Fig.1-1 Switching Time Measurement Circuit

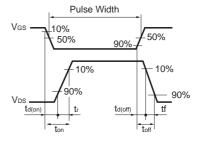


Fig.1-2 Switching Waveforms

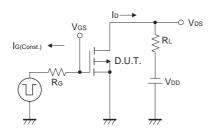
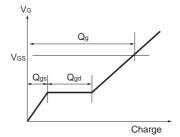


Fig.2-1 Gate Charge Measurement Circuit



Flg.2-2 Gate Charge Waveform

# Notice

- 1. SBD has a large reverse leak current compared to other type of diode. Therefore; it would raise a junction temperature, and increase a reverse power loss. Further rise of inside temperature would cause a thermal runaway.
  - This built-in SBD has low VF characteristics and therefore, higher leak current. Please consider enough the surrounding temperature, generating heat of MOSFET and the reverse current.
- 2. This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

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